

C1300-30

NIR LED CHIP

<Specifications>

Commodity Type and Physical Characteristics	
Material	InGaAsP/InP(DDH)
Top Side P(anode)side	Au Alloy
Bottom Side N(cathode)side	Au Alloy
Electrode Pattern	Fig.1
Chip Size	Fig.2
Chip Thickness	Fig.2
Emission Area	Fig.2

Electro-Optical Characteristics[Ta=25°C]						
Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Forward Voltage	VF	IF=20mA		0.9	1.2	V
		IF=50mA		1.0	1.3	
Reverse Current	IR	VR=3V			10	uA
Power Intensity*	PO	IF=20mA		1.5		mW
		IF=50mA		3.0		
Peak Wavelength	λP	IF=20mA		1300		nm
Spectral Radiation Bandwidth	$\Delta\lambda$	IF=20mA		90		nm
Rise Time	tr	IF=20mA		25		ns
Fall Time	tf	IF=20mA		20		ns

* Measured by PD G8370-85

Die shall be mounted on TO-18 gold header without resin coated.

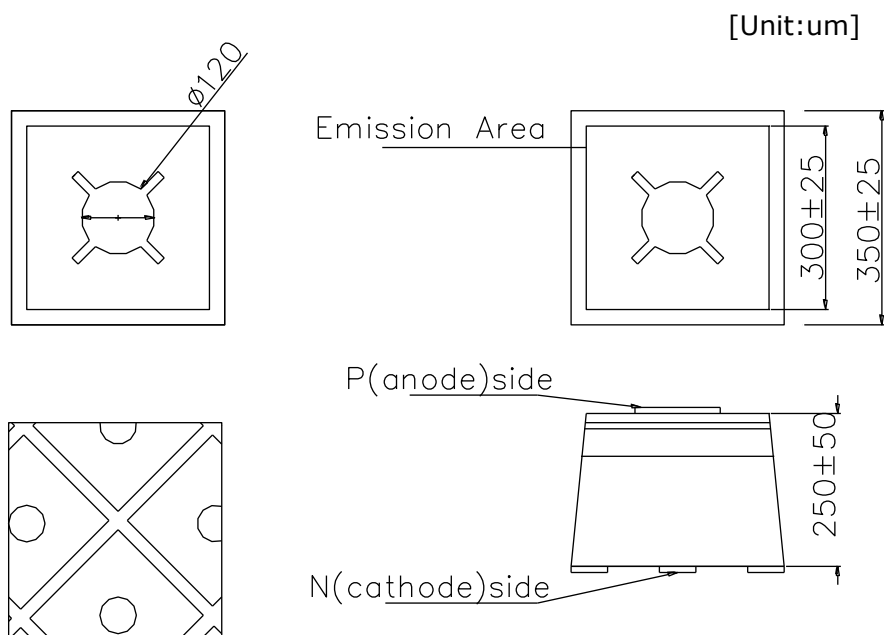


Fig.1 Electrode Pattern

Fig.2 Chip Size and Emission Area